1-880584-2 ACTIVE

AMP

TE Internal #: 1-880584-2

Board-to-Board Jumpers & Shunts, Novo, Closed Top, Board-to-Board, 2 Position, .1 in [2.54 mm] Centerline, Printed Circuit Board,

Signal, Board Mount

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Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Jumpers & Shunts



Shunt Type: Novo

Shunt Style: Closed Top

Connector System: Board-to-Board

Number of Positions: 2

Centerline (Pitch): 2.54 mm [.1 in]

Features

Product Type Features

Product Type Features	
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	2
Electrical Characteristics	
Termination Resistance	15 mΩ
Insulation Resistance	5000 MΩ
Body Features	
Handle	With
Contact Features	
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Mating Area Plating Material	Gold

Phosphor Bronze

Novo

3 A

Closed Top

Mechanical Attachment

Contact Current Rating (Max)

Contact Base Material

Shunt Type

Shunt Style



Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Thermoplastic
Housing Color	Black
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Product Height	8.89 mm[.35 in]
Usage Conditions	
Operating Temperature Range	-40 - 85 °C[-40 - 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Jumper & Shunt Packaging	Loose Piece
Packaging Quantity	14000
Packaging Method	Loose Piece

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts







Customers Also Bought











Documents

Product Drawings
SHUNT CONN. ASS'Y

English

CAD Files

Customer View Model



ENG_CVM_1-880584-2_L.3d_igs.zip

English

Customer View Model

ENG_CVM_1-880584-2_L.3d_stp.zip

English

Customer View Model

ENG_CVM_1-880584-2_L.2d_dxf.zip

English

3D PDF

English

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Product Specifications

Product Specification

English